CVD SILICON CARBIDE® Material Specification for Grades: SC-001, SC-002, SC-003

Properties	Typical Values ⁽¹⁾
Crystal Structure	FCC(face-centered cubic);
	polycrystalline, B-phase
Sublimation Temperature (C)	~2700
Average Grain Size (µm)	5
Density (g cm ⁻³)	3.21
Hardness (kg mm ⁻²)	
Knoop (500 g load)	2540
Vickers (500 g load)	2500
Chemical Purity ⁽²⁾	≥99.9995% SiC
Flexural Strength, (MPa/Ksi) 4-point ⁽³⁾	
@ RT	415/60
@ 1400°C	575/84
Weibull Parameters	
Modulus, m	11
Scale Factor, ß (MPa/Ksi)	424/61
Fracture Toughness, K _{IC} Values	
Micro-indentation (MN m ^{-1.5})	3.3
Controlled Flow (MN m ^{-1.5})	2.7
Elastic Modulus	
Sonic (GPa/10 ⁶ psi)	466/68
4-point Flexure (GPa/10 ⁶ psi)	461/67
Coefficient of Thermal Expansion (K ⁻¹)	
@ RT	2.2 x 10 ⁻⁶
@ RT to 1000°C	4.0 x 10 ⁻⁶
Heat Capacity(Jkg ⁻¹ K ⁻¹)	640
Poisson's Ratio	0.21
Polishability ⁽⁴⁾	<3Å RMS
Thermal Conductivity (Wm ⁻¹ K ⁻¹)	
SC-001, SC-003	300
SC-002	285
Electrical Resistivity $^{(5)}(\Omega cm)$	
SC-002	<1
SC-003	>1000

- (1) Average values at room temperature unless otherwise specified.
- (2) Total metallic impurities; detailed data on specific impurities is available on request.
- (3) Flexure beams had a 0.5 µm RMS surface finish.
- (4) Polishability was measured with an optical profilometer.
- (5) Measured according to ASTM standard.

Solid CVD SILICON CARBIDE is an ultra-pure material with superior thermal and physical properties that are a result of Advanced Materials' bulk chemical vapor deposition (CVD) process. All three grades of CVD SILICON CARBIDE excel in high performance applications that require high temperature (>1500 °C), wear, and chemical resistance performance. Two grades provide controlled electrical resistivity properties: SC-002 Low Resistivity Grade (<1 Ω cm) and SC-003 High Resistivity Grade (>1,000 Ω cm); while the resistivity is not specified in the third grade, SC-001 Standard Grade.

